



TE0710 Test Board

Revision v.9

Exported on 2024-02-19

Online version of this document:

<https://wiki.trenz-electronic.de/display/PD/TE0710+Test+Board>

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4 Overview

Microblaze Design with linux example.

Refer to <http://trenz.org/te0710-info> for the current online version of this manual and other available documentation.

For directly getting started with the prebuilt files jump to the section [Launch](#) (see page 15).

4.1 Key Features

- Vitis/Vivado 2021.2
- PetaLinux
- MicroBlaze
- SPI ELF Bootloader
- Flash
- MIG
- ETH(ETH1 and ETH2)
- LED
- EEPROM MAC
- SDcard interface(Beta, not for boot!)

4.2 Revision History

Date	Vivado	Project Built	Authors	Description
2022-02-16	2021.2	TE0710-test_board_noprebuilt-vivado_2021.2-build_11_20220216112910.zip TE0710-test_board-vivado_2021.2-build_11_20220216112910.zip	Walde mar Hane mann	<ul style="list-style-type: none"> • new spi bootloader by Henrik Brix Andersen • adjusted offsets
2022-02-04	2021.2	TE0710-test_board-vivado_2021.2-build_11_20220208153036.zip TE0710-test_board_noprebuilt-vivado_2021.2-build_11_20220208153036.zip	Walde mar Hane mann	<ul style="list-style-type: none"> • 2021.2 update • document style update • added boot script • added eeprom interface for MAC address read-out • added simple sd card interface • added 2nd Ethernet Interface

Date	Vivado	Project Built	Authors	Description
2020-04-21	2019.2	TE0710-test_board-vivado_2019.2-build_10_20200421063949.zip TE0710-test_board_noprebuilt-vivado_2019.2-build_10_20200421064005.zip	John Hartfiel	<ul style="list-style-type: none"> 2019.2 update
2018-03-29	2017.4	te0710-test_board-vivado_2017.4-build_07_20180329130739.zip te0710-test_board_noprebuilt-vivado_2017.4-build_07_20180329130757.zip	John Hartfiel	<ul style="list-style-type: none"> initial release

Table 1: Design Revision History

4.3 Release Notes and Known Issues

Issues	Description	Workaround	To be fixed version
No known issues	---	---	---

Table 2: Known Issues

4.4 Requirements

4.4.1 Software

Software	Version	Note
Vitis	2021.2	needed, Vivado is included into Vitis installation
PetaLinux	2021.2	needed

Table 3: Software

4.4.2 Hardware

Basic description of TE Board Part Files is available on [TE Board Part Files](#).¹

Complete List is available on "<project folder>\board_files*_board_files.csv"

Design supports following modules:

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	EM MC	Others	Notes
TE0710-02-35-2CF	35_2cf_512mb	REV02	512MB	32MB	NA	NA	less IOs
TE0710-02-35-2IF	35_2if_512mb	REV02	512MB	32MB	NA	NA	less IOs
TE0710-02-100-2CF	100_2cf_512mb	REV02	512MB	32MB	NA	NA	NA
TE0710-02-100-2IF*	100_2if_512mb	REV02	512MB	32MB	NA	NA	NA

Table 4: Hardware Modules

*used as reference

Design supports following carriers:

Carrier Model	Notes
TE0701	
TE0703	used as reference carrier
TE0705	
TE0706	
TEBA0841	

Table 5: Hardware Carrier

*used as reference

Additional HW Requirements:

¹ <https://wiki.trenz-electronic.de/display/PD/TE+Board+Part+Files>

Additional Hardware	Notes
USB Cable for JTAG/UART	Check Carrier Board and Programmer for correct typ
XMOD Programmer	Carrier Board dependent, only if carrier has no own FTDI

Table 6: Additional Hardware

* used as reference

4.5 Content

For general structure and usage of the reference design, see [Project Delivery - AMD devices](#)²

4.5.1 Design Sources

Type	Location	Notes
Vivado	<project folder>\block_design <project folder>\constraints <project folder>\ip_lib <project folder>\board_files	Vivado Project will be generated by TE Scripts
Vitis	<project folder>\sw_lib	Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation
PetaLinux	<project folder>\os\petalinux	PetaLinux template with current configuration

Table 7: Design sources

² <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices>

4.5.2 Additional Sources

Type	Location	Notes

Table 8: Additional design sources

4.5.3 Prebuilt

File	File-Extension	Description
BIT-File	*.bit	FPGA (PL Part) Configuration File
Boot Script-File	*.scr	Distro Boot Script file
DebugProbes-File	*.ltx	Definition File for Vivado/Vivado Labtools Debugging Interface
Diverse Reports	---	Report files in different formats
Hardware-Platform-Specification-Files	*.xsa	Exported Vivado Hardware Specification for Vitis and PetaLinux
LabTools Project-File	*.lpr	Vivado Labtools Project File
OS-Image	*.ub	Image with Linux Kernel (On Petalinux optional with Devicetree and RAM-Disk)
Software-Application-File	*.elf	Software Application for Zynq or MicroBlaze Processor Systems
SREC-File	*.srec	Converted Software Application for MicroBlaze Processor Systems

Table 9: Prebuilt files (only on ZIP with prebuilt content)

4.5.4 Download

Reference Design is only usable with the specified Vivado/Vitis/PetaLinux version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

- [TE0710 "Test Board" Reference Design](#)³

³ https://shop.trenz-electronic.de/Download/?path=Trenz_Electronic/Modules_and_Module_Carriers/4x5/TE0710/Reference_Design/2021.2/test_board

5 Design Flow

! Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first launch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also:

- [Xilinx Development Tools#XilinxSoftware-BasicUserGuides](#)⁴
- [Vivado Projects - TE Reference Design](#)⁵
- [Project Delivery](#).⁶

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "_create_win_setup.cmd" on Windows OS and "_create_linux_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also be executed by Xilinx Vivado/Vitis GUI. For currently Scripts limitations on Win and Linux OS see: [Project Delivery Currently limitations of functionality](#)⁷

! **Caution!** Win OS has a 260 character limit for path lengths which can affect the Vivado tools. To avoid this issue, use Virtual Drive or the shortest possible names and directory locations for the reference design (for example "x:\<project folder>")

1. Run _create_win_setup.cmd/_create_linux_setup.sh and follow instructions on shell:

_create_win_setup.cmd/_create_linux_setup.sh

```
-----Set design paths-----
-- Run Design with: _create_win_setup
-- Use Design Path: <absolute project path>
-----
-----TE Reference Design-----
-----
-- (0)  Module selection guide, project creation...prebuilt export...
-- (1)  Create minimum setup of CMD-Files and exit Batch
-- (2)  Create maximum setup of CMD-Files and exit Batch
-- (3)  (internal only) Dev
-- (4)  (internal only) Prod
-- (c)  Go to CMD-File Generation (Manual setup)
-- (d)  Go to Documentation (Web Documentation)
-- (g)  Install Board Files from Xilinx Board Store (beta)
-- (a)  Start design with unsupported Vivado Version (beta)
-- (x)  Exit Batch (nothing is done!)
----
Select (ex.: '0' for module selection guide):
```

2. Press 0 and enter to start "Module Selection Guide"
3. Create project and follow instructions of the product selection guide, settings file will be configured automatically during this process.


⁴ <https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools>

⁵ <https://wiki.trenz-electronic.de/display/PD/Vivado+Projects+-+TE+Reference+Design>

⁶ <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices>

⁷ <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+AMD+devices>


- optional for manual changes: Select correct device and Xilinx install path on "design_basic_settings.cmd" and create Vivado project with "vivado_create_project_gui mode.cmd"

 Note: Select correct one, see also [Vivado Board Part Flow](#)⁸


4. Create hardware description file (.xsa file) for PetaLinux project and export to prebuilt folder

run on Vivado TCL (Script generates design and export files into "\prebuilt\hardware\")

```
\prebuilt\hardware\")">
TE::hw_build_design -export_prebuilt
```

 Using Vivado GUI is the same, except file export to prebuilt folder.


5. Create and configure your PetaLinux project with exported .xsa-file, see [PetaLinux KICKstart](#)⁹
 - use TE Template from "<project folder>\os\petalinux"
 - use exported .xsa file from "<project folder>\prebuilt\hardware<short name>". **Note:** HW Export from Vivado GUI creates another path as default workspace.
 - **Important Note:** Select correct Flash partition offset on petalinux-config: Subsystem Auto HW Settings → Flash Settings, FPGA+Boot+bootenv=0xA00000 (increase automatically generate Boot partition), increase image size to A; see [Config \(see page 21\)](#)
 - The build images are located in the "<plnx-proj-root>/images/linux" directory
6. Configure the **boot.scr** file as needed, see [Distro Boot with Boot.scr](#)¹⁰
7. Copy PetaLinux build image files to prebuilt folder
 - copy **u-boot.elf** and **image.ub** from "<plnx-proj-root>/images/linux" to prebuilt folder

 "<project folder>\prebuilt\os\petalinux\<ddr size>" or "<project folder>\prebuilt\os\petalinux\<short name>"

8. Generate Programming Files with Vitis

run on Vivado TCL (Script generates applications and bootable files, which are defined in "test_board\sw_lib\apps_list.csv")

```
TE::sw_run_vitis -all
TE::sw_run_vitis (optional; Start Vitis from Vivado GUI or start with TE
Scripts on Vivado TCL)
```

 TCL scripts generate also platform project, this must be done manually in case GUI is used. See [Vitis](#)¹¹

9. (Optional) BlockRam Firmware Update
 - a. Copy "<project folder>\prebuilt\software\<short name>\spi_bootloader.elf" into "<project folder>\firmware\microblaze_0\"
 - b. Regenerate Vivado Project or Update Bitfile only with "spi_bootloader.elf"

⁸ <https://wiki.trenz-electronic.de/display/PD/Vivado+Board+Part+Flow>

⁹ <https://wiki.trenz-electronic.de/display/PD/PetaLinux+KICKstart>


¹⁰ <https://wiki.trenz-electronic.de/display/PD/Distro+Boot+with+Boot.scr>

¹¹ <https://wiki.trenz-electronic.de/display/PD/Vitis>

```
TE::hw_build_design -export_prebuilt  
TE::sw_run_vitis -all
```

6 Launch


6.1 Programming

 Check Module and Carrier TRMs for proper HW configuration before you try any design. Reference Design is also available with prebuilt files. It's recommended to use TE prebuilt files for first launch.

Xilinx documentation for programming and debugging: [Vivado/Vitis/SDSoC-Xilinx Software Programming and Debugging](#)¹²

6.1.1 Get prebuilt boot binaries

1. Run `_create_win_setup.cmd/_create_linux_setup.sh` and follow instructions on shell
2. Press 0 and enter to start "Module Selection Guide"
 - a. Select assembly version
 - b. Validate selection
 - c. Select create and open delivery binary folder

 Note: Folder "<project folder>_binaries_<Article Name>" with subfolder "boot_<app name>" for different applications will be generated

6.1.2 QSPI-Boot mode

Option for **u-boot.mcs** on QSPI Flash.
(u-boot.mcs contains all files necessary to boot up linux)

1. Connect the **USB cable**(JTAG) and **power supply** on carrier with module
2. Open Vivado Project with "vivado_open_existing_project_gui mode.cmd" or if not created, create with "vivado_create_project_gui mode.cmd"

run on Vivado TCL (Script programs BOOT.bin on QSPI flash)

```
TE::pr_program_flash -swapp u-boot
```

3. Reboot (if not done automatically)

6.1.3 SD-Boot mode

Not used on this Example.


6.1.4 JTAG


Not used on this example.

¹² <https://wiki.trenz-electronic.de/display/PD/AMD+Development+Tools>

6.2 Usage

1. Prepare HW like described on section [Programming](#) (see page 15)
2. Connect UART USB (most cases same as JTAG)
3. Select SD Card as Boot Mode (or QSPI - depending on step 1)

 Note: See TRM of the Carrier, which is used.

 Starting with Petalinux version 2020.1, the industry standard "Distro-Boot" boot flow for U-Boot was introduced, which significantly expands the possibilities of the boot process and has the primary goal of making booting much more standardised and predictable. The boot options described above describe the common boot processes for this hardware; other boot options are possible. For more information see [Distro Boot with Boot.scr](#)¹³

4. Power On PCB

boot process

1. FPGA Loads Bitfile from Flash,
2. SPI Bootloader from Bitfile Firmware loads U-Boot into DDR (This takes a while)

```
SPI ELF Bootloader
Copying ELF image from SPI flash @ 0x005e0000 to RAM
.....
.....
.....
.....
Transferring execution to program @ 0x80100000

U-Boot 2021.01 (Oct 12 2021 - 09:28:42 +0000)

Model: Xilinx MicroBlaze
DRAM: 512 MiB
WDT: Not found!
In: serial
Out: serial
Err: serial
Model: Xilinx MicroBlaze
```

3. U-boot loads Linux from QSPI Flash into DDR

6.2.1 Linux

1. Open Serial Console (e.g. putty)
 - Speed: 9600
 - select COM Port

¹³ <https://wiki.trenz-electronic.de/display/PD/Distro+Boot+with+Boot.scr>

i Win OS, see device manager, Linux OS see dmesg |grep tty (UART is *USB1)

2. Linux Console:

```
petalinux login: root
Password: root
```

i Note: Wait until Linux boot finished

3. You can use Linux shell now.

```
udhcpc          (ETH0 check)
```

6.2.2 Vivado HW Manager

Open Vivado HW-Manager and add VIO signal to dashboard (*.ltx located on prebuilt folder)

- Control:
 - User LED Control
 - ETH Power Down
- Monitoring:
 - ETH Link Status
 - MicroBlaze Reset Status

HARDWARE MANAGER - localhost/xilinx_tcf/Digilent/25163300025CA

Name	Status
localhost (1)	Connected
xilinx_tcf/Digilent/2516330002...	Open
xc7a35t_0 (3)	Programmed
XADC (System Monitor)	
hw_vio_1 (msys_iVio_0)	OK - Outputs F
s25fl256sxxxxx0-spi-x1_x...	

hw_vios

Name	Value	Activity	Direction	VIO
msys_i/ETH1_PD_N[0:0]	[B] 1		Output	hw_vio_1
msys_i/ETH2_PD_N[0:0]	[B] 0		Output	hw_vio_1
msys_i/LED_RED_D3[0:0]	[B] 0		Output	hw_vio_1
msys_i/LED_RED_XA_SC[0:0]	[B] 0		Output	hw_vio_1
msys_i/rst_mig_7series_0_100M_mb_reset	[B] 0		Input	hw_vio_1
msys_iVio_ETH1_LINK_LED	[B] 0		Input	hw_vio_1
msys_iVio_ETH2_LINK_LED	[B] 1		Input	hw_vio_1

Figure 1: Vivado_Hardware_Manager

System Design - Vivado


```
set_property BITSTREAM.CONFIG.USR_ACCESS_TIMESTAMP [current_design]
```

_i_bitgen.xdc

```
set_property BITSTREAM.CONFIG.UNUSEDPIN PULLDOWN [current_design]
```

6.4.2 Design specific constraints

_i_io.xdc

```
set_property PACKAGE_PIN G3 [get_ports {LED_RED_XA_SC[0]}]
set_property IOSTANDARD LVCMOS15 [get_ports {LED_RED_XA_SC[0]}]

set_property PACKAGE_PIN T10 [get_ports {ETH2_LINK_LED[0]}]
set_property IOSTANDARD LVCMOS33 [get_ports {ETH2_LINK_LED[0]}]
set_property PACKAGE_PIN V15 [get_ports {ETH1_LINK_LED[0]}]
set_property IOSTANDARD LVCMOS33 [get_ports {ETH1_LINK_LED[0]}]
set_property PACKAGE_PIN T18 [get_ports {ETH1_PD_N[0]}]
set_property PACKAGE_PIN D10 [get_ports {ETH2_PD_N[0]}]
set_property IOSTANDARD LVCMOS33 [get_ports {ETH2_PD_N[0]}]
set_property IOSTANDARD LVCMOS33 [get_ports {ETH1_PD_N[0]}]

set_property PACKAGE_PIN L15 [get_ports {LED_RED_D3[0]}]
set_property IOSTANDARD LVCMOS33 [get_ports {LED_RED_D3[0]}]

#EEPROM onewire (MAC ADDRESS)
set_property IOSTANDARD LVCMOS33 [get_ports EEPROM_tri_io]
set_property PACKAGE_PIN D9 [get_ports EEPROM_tri_io]

#SD Card SPI
set_property PACKAGE_PIN B9 [get_ports sclk_o_0]
set_property IOSTANDARD LVCMOS33 [get_ports sclk_o_0]
set_property PACKAGE_PIN C11 [get_ports cs_bo_0]
set_property PACKAGE_PIN A9 [get_ports miso_i_0]
set_property PACKAGE_PIN C9 [get_ports mosi_o_0]
set_property IOSTANDARD LVCMOS33 [get_ports mosi_o_0]
set_property IOSTANDARD LVCMOS33 [get_ports miso_i_0]
set_property IOSTANDARD LVCMOS33 [get_ports cs_bo_0]
```

7 Software Design - Vitis

For Vitis project creation, follow instructions from:

[Vitis](#)¹⁴

7.1 Application

Template location: "<project folder>\sw_lib\sw_apps\"

7.1.1 spi_bootloader

TE modified SPI Bootloader from [Henrik Brix Andersen](#)¹⁵.

Bootloader to load app or second bootloader from flash into DDR.

Here it loads the u-boot.elf from QSPI-Flash to RAM. Hence u-boot.srec becomes redundant.

Descriptions:

- Modified Files: bootloader.c
- Changes:
 - Change the SPI defines in the header
 - Add some reiteration in the frist spi read call

7.1.2 hello_te0710

Hello TE0710 is a Xilinx Hello World example as endless loop instead of one console output.

7.1.3 u-boot

U-Boot.elf is generated with PetaLinux. Vitis is used to generate u-boot.srec(obsolete). Vivado to generate *.mcs

¹⁴ <https://wiki.trenz-electronic.de/display/PD/Vitis>

¹⁵ <https://github.com/henrikbrixandersen/elf-bootloader>

8 Software Design - PetaLinux

For PetaLinux installation and project creation, follow instructions from:

- [PetaLinux KICKstart](#)¹⁶

8.1 Config

Start with **petalinux-config** or **petalinux-config --get-hw-description**

Changes:

- SUBSYSTEM_FLASH_AXI_QUAD_SPI_0_BANKLESS_PART0_SIZE = **0x5E0000** (fpga)
- SUBSYSTEM_FLASH_AXI_QUAD_SPI_0_BANKLESS_PART1_SIZE = **0x400000** (boot)
- SUBSYSTEM_FLASH_AXI_QUAD_SPI_0_BANKLESS_PART2_SIZE = **0x20000** (bootenv)
- SUBSYSTEM_FLASH_AXI_QUAD_SPI_0_BANKLESS_PART3_SIZE = **0xA00000** (kernel)
 - (Set kernel flash Address to 0xA00000 (fpga+boot+bootenv) and Kernel size to 0xA00000)

8.2 U-Boot

Start with **petalinux-config -c u-boot**

Changes:

- CONFIG_ENV_IS_NOWHERE=y
- # CONFIG_ENV_IS_IN_SPI_FLASH is not set
- # CONFIG_PHY_ATHEROS is not set
- # CONFIG_PHY_BROADCOM is not set
- # CONFIG_PHY_DAVICOM is not set
- # CONFIG_PHY_LXT is not set
- # CONFIG_PHY_MICREL_KSZ90X1 is not set
- # CONFIG_PHY_MICREL is not set
- # CONFIG_PHY_NATSEMI is not set
- # CONFIG_PHY_REALTEK is not set
- CONFIG_RGMII=y

Content of **platform-top.h** located in <plnx-proj-root>\project-spec\meta-user\recipes-bsp\u-boot\files:

```
#include <configs/microblaze-generic.h>
#include <configs/platform-auto.h>

#define CONFIG_SYS_BOOTM_LEN 0xF000000
```

8.3 Device Tree

Content of **system-user.dtsi** located in <petalinux project directory>\project-spec\meta-user\recipes-bsp\device-tree\files:

¹⁶ <https://wiki.trenz-electronic.de/display/PD/PetaLinux+KICKstart>

```

/include/ "system-conf.dtsi"
/ {
};

/* QSPI PHY */

&axi_quad_spi_0 {
    #address-cells = <1>;
    #size-cells = <0>;
    flash0: flash@0 {
        compatible = "jedec,spi-nor";
        spi-tx-bus-width=<1>;
        spi-rx-bus-width=<4>;
        reg = <0x0>;
        #address-cells = <1>;
        #size-cells = <1>;
        spi-max-frequency = <25000000>;
    };
};

/* ETH PHY */
&axi_ethernetlite_0 {
    phy-handle = <&phy0>;
    mdio {
        #address-cells = <1>;
        #size-cells = <0>;
        phy0: phy@0 {
            device_type = "ethernet-phy";
            reg = <1>;
        };
    };
};

/* ETH 2nd PHY */
&axi_ethernetlite_1 {

    phy-handle = <&phy1>;
    mdio {
        #address-cells = <1>;
        #size-cells = <0>;
        phy1: phy@1 {
            device_type = "ethernet-phy";
            reg = <1>;
        };
    };
};

```

8.4 Kernel

Start with **petalinux-config -c kernel**

Changes:

- No changes.

8.5 Rootfs

Start with **petalinux-config -c rootfs**

Changes:

- # CONFIG_dropbear is not set
- # CONFIG_dropbear-dev is not set
- # CONFIG_dropbear-dbg is not set
- # CONFIG_packagegroup-core-ssh-dropbear is not set
- # CONFIG_packagegroup-core-ssh-dropbear-dev is not set
- # CONFIG_packagegroup-core-ssh-dropbear-dbg is not set
- # CONFIG_imagefeature-ssh-server-dropbear is not set

8.6 Applications

See "<project folder>\os\petalinux\project-spec\meta-user\recipes-apps\"

8.6.1 eeprom

eeprom is a simple bash script implemented in petalinux as an application that executes on startup. It reads the unique 48-bit MAC from the onboard eeprom and uses it to set the system MAC address.

sdtoscript(Beta)

sdtoscript is a petalinux C-Application that reads raw data at a predetermined address from a <2GB sd card and writes it to a file in petalinux. It is only suitable for low level raw data transfer.

9 Additional Software

No additional software is needed.

10 App. A: Change History and Legal Notices

10.1 Document Change History

To get content of older revision go to "Change History" of this page and select older document revision number.

Date	Document Revision	Authors	Description
 2022-02-16	v.9 (see page 6)	John Hartfiel ¹⁷	<ul style="list-style-type: none"> • bugfix documenten style
2022-02-16	v.8	Waldemar Hanemann	<ul style="list-style-type: none"> • new spi bootloader by Henrik Brix Andersen • adjusted offsets
2022-02-14	v.7	Waldemar Hanemann	<ul style="list-style-type: none"> • 2021.2 update • document style update • added boot script • added eeprom interface for MAC address read-out • added simple sd card interface • added 2nd Ethernet Interface
2020-04-21	v.5	@John Hartfiel	<ul style="list-style-type: none"> • Release 2019.2 • Docu update
2019-03-29	v.4	John Hartfiel	<ul style="list-style-type: none"> • Release 2017.4
2019-03-29	v.1	@ John Hartfiel ¹⁸	<ul style="list-style-type: none"> • Initial release
---	All	@ John Hartfiel ¹⁹ , Waldemar Hanemann ²⁰	---

Table 10: Document change history.

¹⁷ <https://wiki.trenz-electronic.de/display/~j.hartfiel>

¹⁸ <https://wiki.trenz-electronic.de/display/~j.hartfiel>

¹⁹ <https://wiki.trenz-electronic.de/display/~j.hartfiel>

²⁰ <https://wiki.trenz-electronic.de/display/~w.hanemann>

10.2 Legal Notices

10.3 Data Privacy

Please also note our data protection declaration at <https://www.trenz-electronic.de/en/Data-protection-Privacy>

10.4 Document Warranty

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10.8 Environmental Protection

To confront directly with the responsibility toward the environment, the global community and eventually also oneself. Such a resolution should be integral part not only of everybody's life. Also enterprises shall be conscious of their social responsibility and contribute to the preservation of our common living space. That is why Trenz Electronic invests in the protection of our Environment.

10.9 REACH, RoHS and WEEE

REACH

Trenz Electronic is a manufacturer and a distributor of electronic products. It is therefore a so called downstream user in the sense of [REACH](#)²¹. The products we supply to you are solely non-chemical products (goods). Moreover and under normal and reasonably foreseeable circumstances of application, the goods supplied to you shall not release any substance. For that, Trenz Electronic is obliged to neither register nor to provide safety data sheet. According to present knowledge and to best of our knowledge, no [SVHC \(Substances of Very High Concern\) on the Candidate List](#)²² are contained in our products. Furthermore, we will immediately and unsolicited inform our customers in compliance with REACH - Article 33 if any substance present in our goods (above a concentration of 0,1 % weight by weight) will be classified as SVHC by the [European Chemicals Agency \(ECHA\)](#)²³.

RoHS


Trenz Electronic GmbH herewith declares that all its products are developed, manufactured and distributed RoHS compliant.

WEEE

Information for users within the European Union in accordance with Directive 2002/96/EC of the European Parliament and of the Council of 27 January 2003 on waste electrical and electronic equipment (WEEE).

Users of electrical and electronic equipment in private households are required not to dispose of waste electrical and electronic equipment as unsorted municipal waste and to collect such waste electrical and electronic equipment separately. By the 13 August 2005, Member States shall have ensured that systems are set up allowing final holders and distributors to return waste electrical and electronic equipment at least free of charge. Member States shall ensure the availability and accessibility of the necessary collection facilities. Separate collection is the precondition to ensure specific treatment and recycling of waste electrical and electronic equipment and is necessary to achieve the chosen level of protection of human health and the environment in the European Union. Consumers have to actively contribute to the success of such collection and the return of waste electrical and electronic equipment. Presence of hazardous substances in electrical and electronic equipment results in potential effects on the environment and human health. The symbol consisting of the crossed-out wheeled bin indicates separate collection for waste electrical and electronic equipment.

Trenz Electronic is registered under WEEE-Reg.-Nr. DE97922676.

 2019-06-07

²¹ <http://guidance.echa.europa.eu/>

²² <https://echa.europa.eu/candidate-list-table>

²³ <http://www.echa.europa.eu/>